

ightarrow ightarrow ightarrow Inductors (Coils) ightarrow Detailed Information

Inductors (Coils)

Product Top Pa	ige Search by Part No	Search by Characteristics	Cross Reference	Catalog	Tech Notes	▼ more
MHQ04	02P1N4CT	000				Image: Solution of the soluti
Applications	Commercial Gra	ade				PDF file of this page
Feature	Non-Mag Core Non-M	on-Mag Core Non-Magnetic Core (Dielectric Ceramic)				Contact
Series Type	MHQ-P					Documents
Status	Production (Not Recommended for New Design) Recommended Alternate Part No. : <u>MHQ0402PSA1N4CT000</u> (Int hangeability is not guaranteed.)) and	Images are for reference only and show exemplary products.		Catalog Catalog RoHS Certificate SVHC/REACH Certificate
Brand	TDK					Product Lineup
						[Selection Guide] Inductors for high frequency applications Update
Size						Sample Kits
		0.44mm ±0.0)2mm			Technical Support Tools
Length(L) Width(W)		0.24mm ±0.0				S-parameter
Thickness Hei	iaht		-			SPICE Netlist (Simple)
•	-		0.24mm ±0.02mm			SPICE Netlist (Precision)
Recommended Land Pattern (A)			0.15mm to 0.20mm			Equivalent Circuit Model
Recommended Land Pattern (B) Recommended Land Pattern (C)			0.20mm Nom.			
Recommended		0.101111100	.2011111			
Electrical Cha	racteristics					
Inductance		1.4nH ±0.2nl	1.4nH ±0.2nH at 500MHz			
Rated Current		320mA	320mA			
DC Resistance [Typ.]		120mΩ				
DC Resistance [Max.]		300mΩ				
Self Resonant I	Frequency [Min.]	8GHz	8GHz			
Self Resonant I	Frequency [Typ.]	11GHz	11GHz			
Q [Min.]		10 at 500MH	10 at 500MHz			
Q [Тур.]		14 at 500MH	14 at 500MHz			
Other						
Operating Temp	o. Range (Including Self-	Temp. Rise) -55 to 125°C				
Soldering Method		Reflow	Reflow			
AEC-Q200 No						
Packing Punched (Pa		Punched (Pa	per)Taping [180mm Reel]			
Package Quan	tity	20000pcs				
Weight			0.00011g			

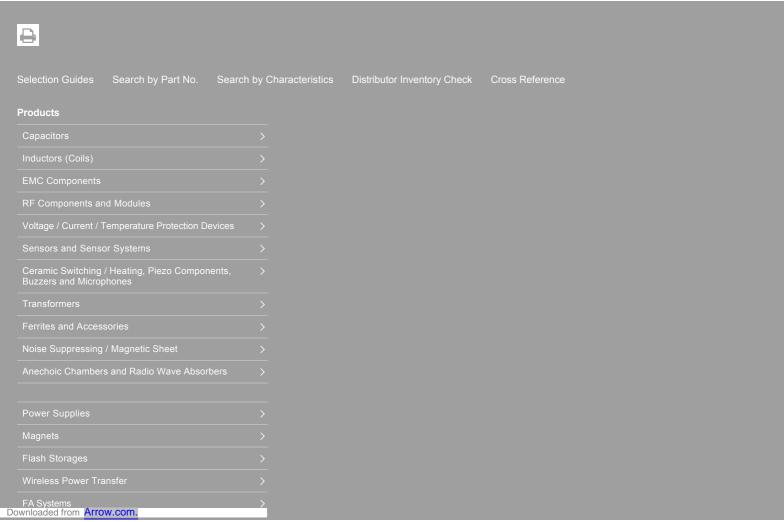
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characteristics.)

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Inductance	Q
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MHQ0402P1N4CT000	MHQ0402P1N4CT000
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Transparent Conductive Film	>	
Micro Modules (Substrates with Built-in ICs, Products Utilizing with SESUB)		
Solar Cells		
Biosensor		
Application Specific IC (ASIC) Development and Supply		
Application Guides		
Technical Support		
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